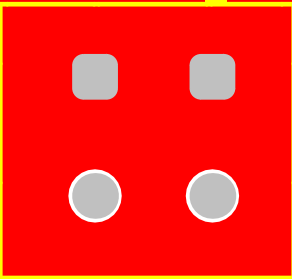


LM74700-Q1 - 21x6mm

LM5140-Q1 - 21x51mm

VIN

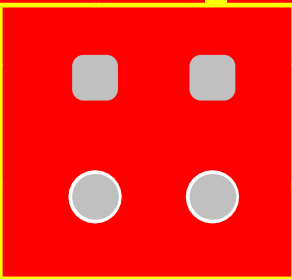


GND

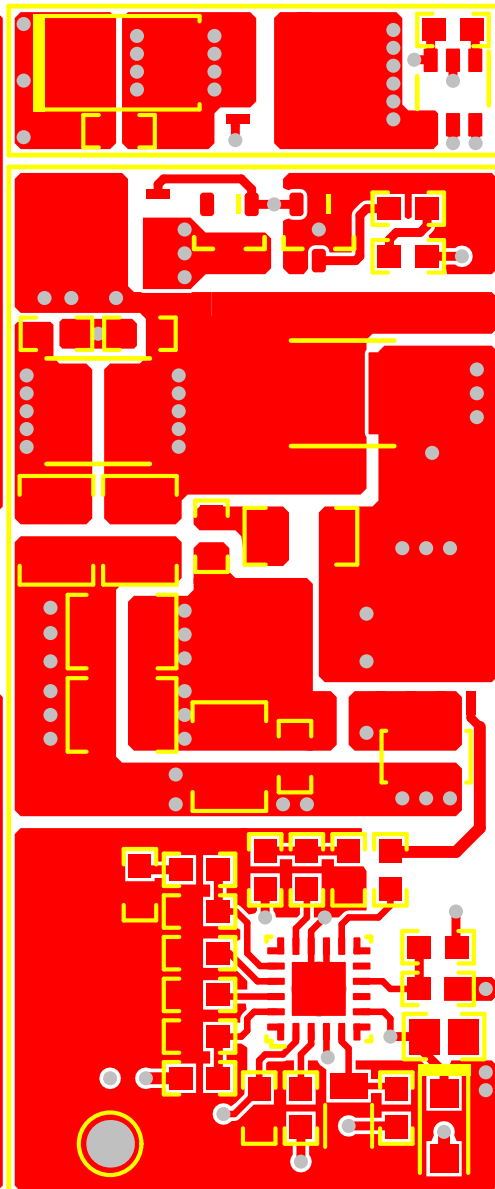
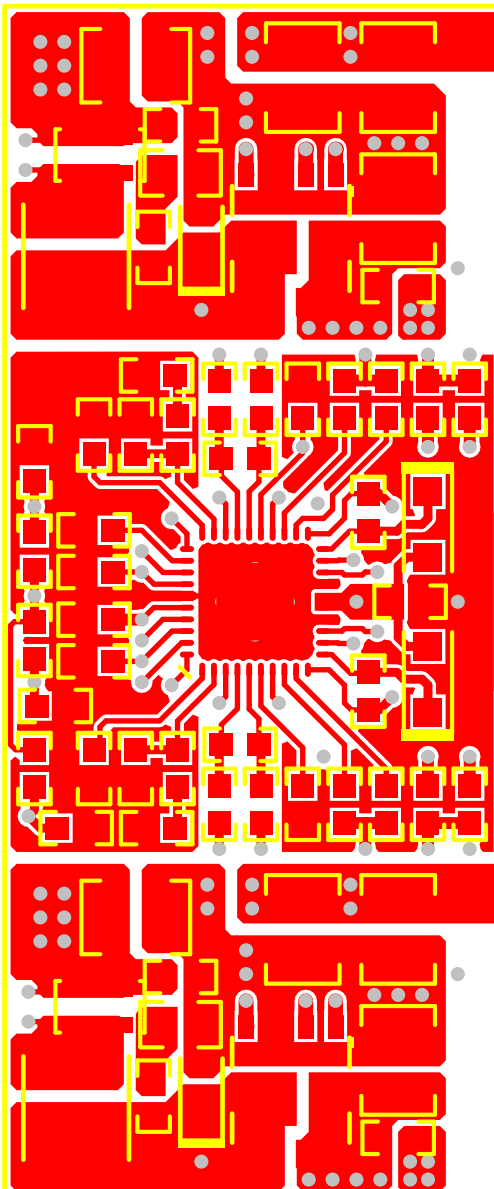
PMP30267

Rev. 

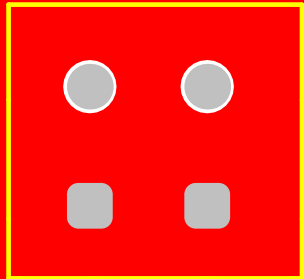
VBOOST




GND


GND



VOUT1

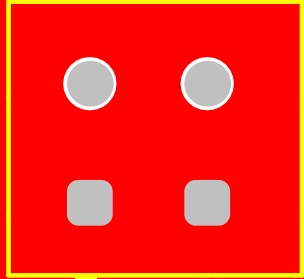


ON
1
OFF




ON
2
OFF

GND

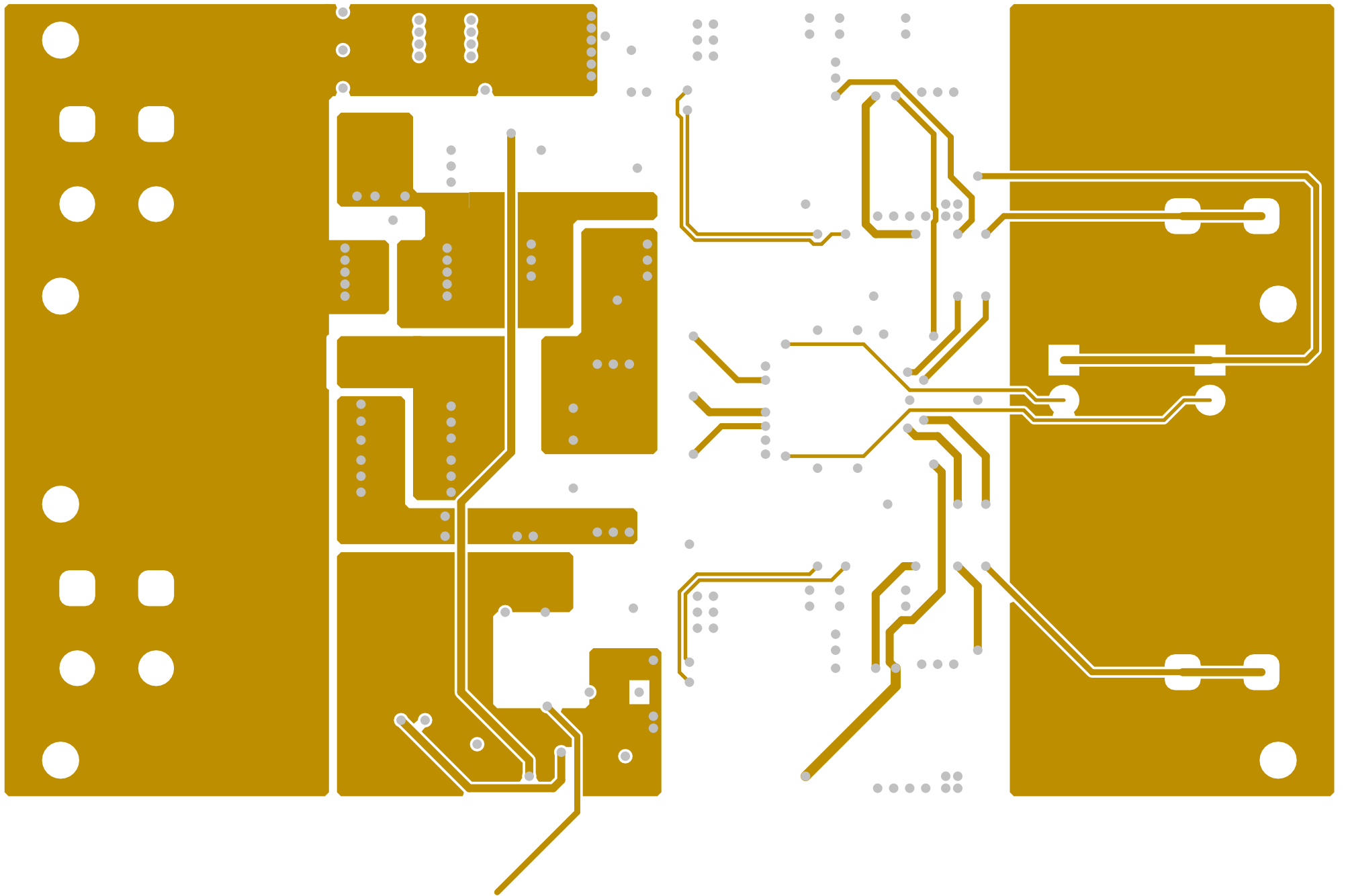


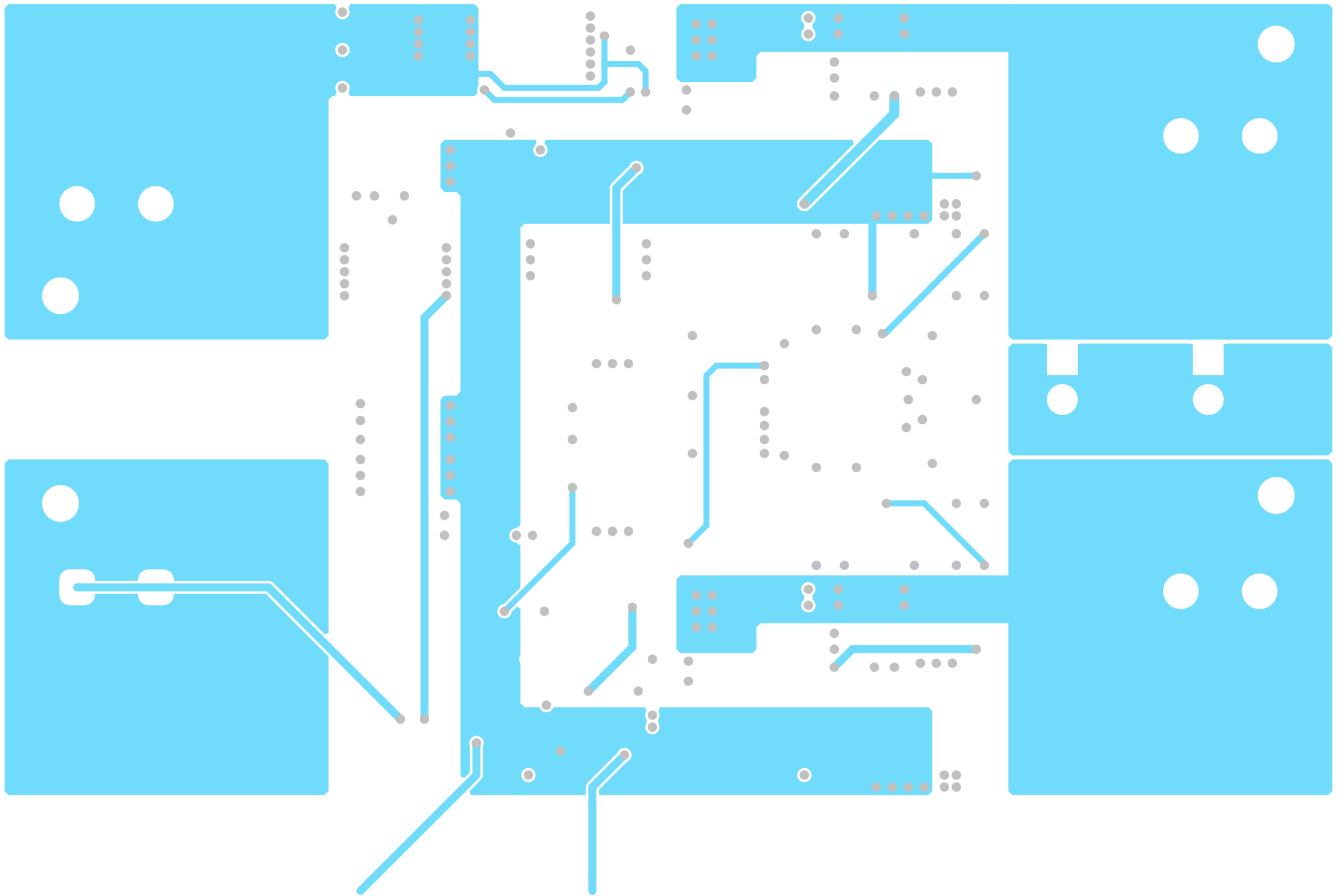
VOUT2

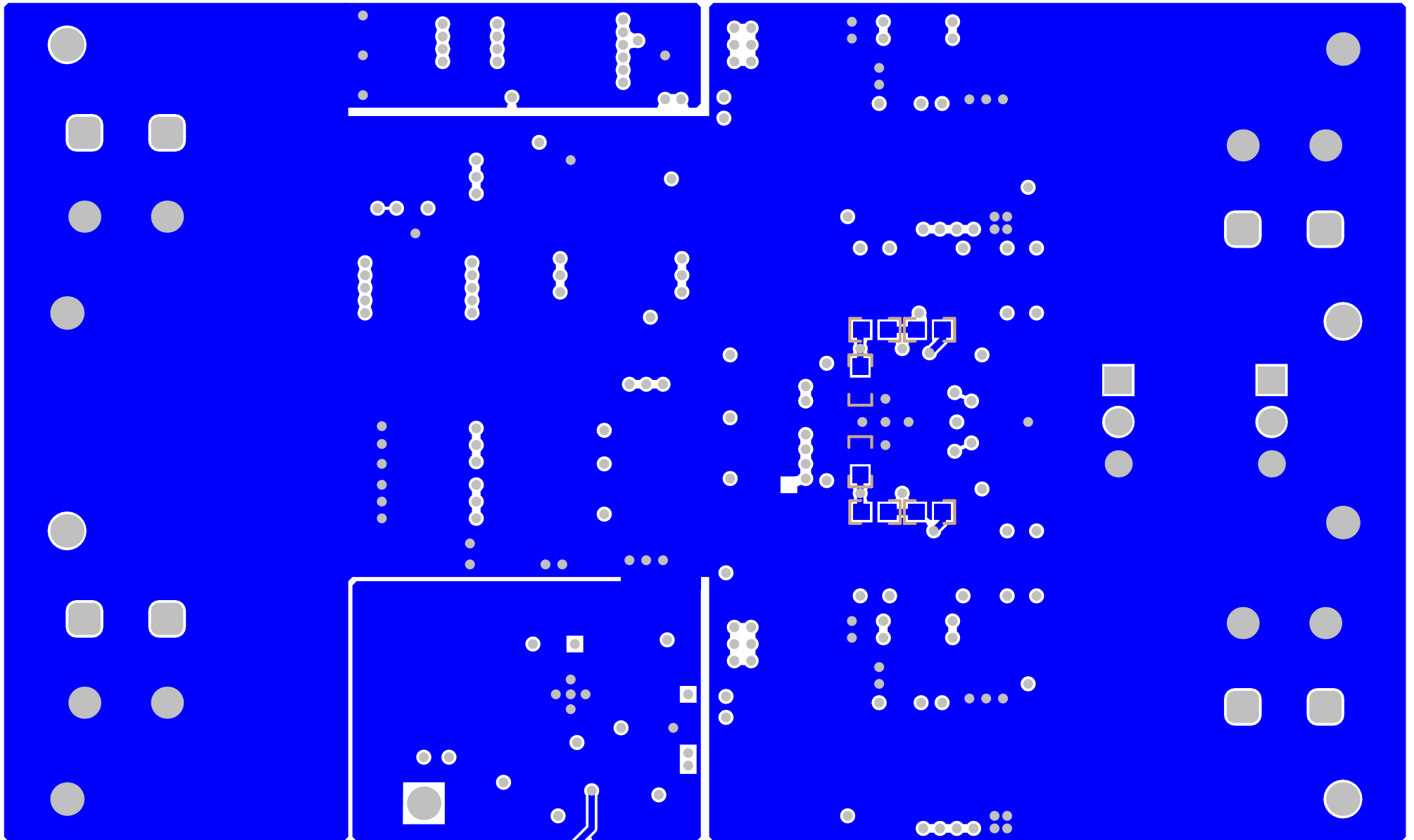
LM5150-Q1 - 21x44mm



SYNC ON OFF BIAS







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